

## Film Capacitors – Power Factor Correction

Key components – Terminal to RJ45 converter

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# **公TDK**

B44066

B44066R1\*11E230

### Film Capacitors – Power Factor Correction

#### Key components – Terminal to RJ45 converter

**Preliminary data** 

#### Characteristics

RJ45 – converter 1xRJ45-BR6000 2xRJ45-BR6000 2xRJ45-MMI6000

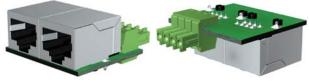
- Terminal to RJ45 converter
- To connect the interface terminal of BR6000, BR7000 or MMI6000 via RJ45-standard cable (1:1)
- Connection of several devices at the RS485 bus with simple connection (one click) Example:
  - Connection of several BR6000 or BR7000 to a PC with BR7000-SOFT
  - Coupling of several BR6000 with each other
  - Coupling of BR6000 or BR7000 with MMI6000



1xRJ45 for BR6000/BR7000



2xRJ45 for BR6000/BR7000



2xRJ45 for MMI6000

Technical data and specifications	
Design	Compact form
Dimensions w × h × l	35 x 15 x 30 mm
Weight	Approx. 0.1 kg
Power supply	None (passive cable adapter)
Variants	
1xRJ45-BR6000	4-pole interface-terminal BR6000/BR7000 to 1xRJ45 jack
2xRJ45-BR6000	4-pole interface-terminal BR6000/BR7000 to 2xRJ45 jack (in parallel)
2xRJ45-MMI6000	4-pole interface-terminal MMI6000 to 2xRJ45 jack
Protection class (IEC 60529)	IP00
Ambient and storage temperature	-20 +60 °C
Ordering codes	
1xRJ45 for BR6000/BR7000	B44066R1611E230
2xRJ45 for BR6000/BR7000	B44066R1711E230
2xRJ45 for MMI6000	B44066R1811E230

FK PC PM PFC



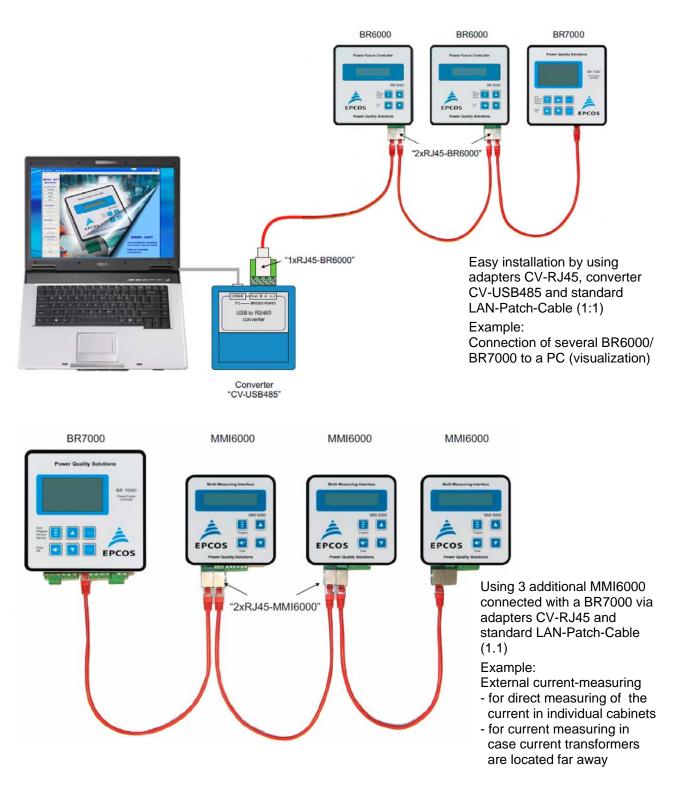
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B44066R1\*11E230 B44066

#### **Preliminary data**

Example: Coupling of several BR6000 for connection to a PC



**Note:** These RJ45 adapters support a RJ485-interface with internal MODBUS protocol. It is not a LAN-interface!

FK PC PM PFC

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